### Switching Diodes

Panasonic

# MA2J1130G

## Silicon epitaxial planar type

For switching circuits

#### Features

- Allowing high-density mounting
- Ensuring the forward current (Average) capacity  $I_{F(AV)} = 200 \text{ mA}$
- High breakdown voltage:  $V_R = 80 V$

- Package
- Code
- SMini2-F3
- Pin Name 1: Anode
  - 2: Cathode

Absolute	Maximum	Ratings	$T_a = 25^{\circ}C$

80	v
80	V
200	mA
600	mA
1	A
150	°C
-55 to +150	°C
	200 600 1 150

Marking Symbol: 1D

Note) \*: t = 1 s

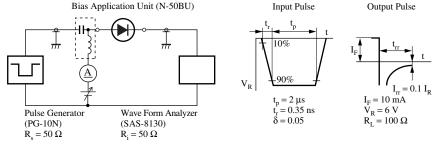
#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	I <sub>F</sub> = 200 mA	20	SO.	1.1	V
Reverse current	IRI	V <sub>R</sub> = 15 V	- A		50	nA
	I <sub>R2</sub>	V <sub>R</sub> = 75 V	, N <sup>2</sup>		500	
	I <sub>R3</sub>	$V_R = 75 V, T_a = 100^{\circ}C$	5.		100	μΑ
Terminal capacitance	Ct	$V_R = 0 V, f = 1 MHz$			4	pF
Reverse recovery time	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			10	ns
		$I_{rr} = 0.1 I_R$ , $R_L = 100 \Omega$				

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

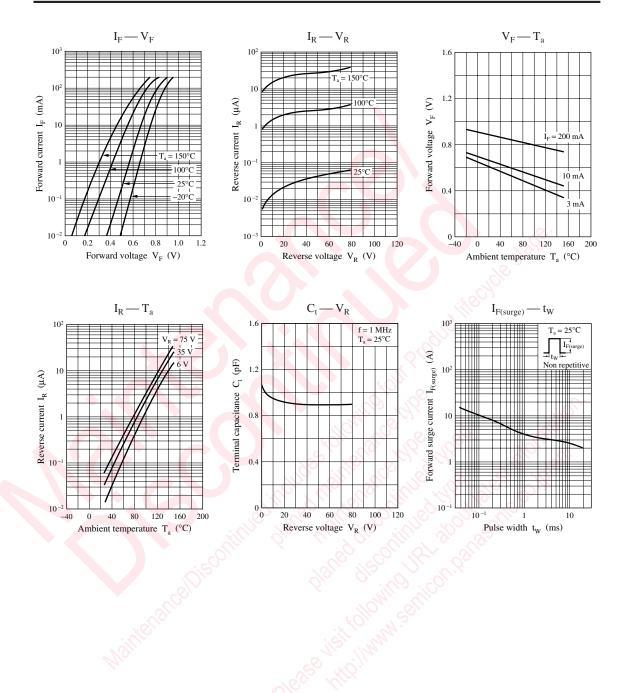
2. Absolute frequency of input and output is 100 MHz.





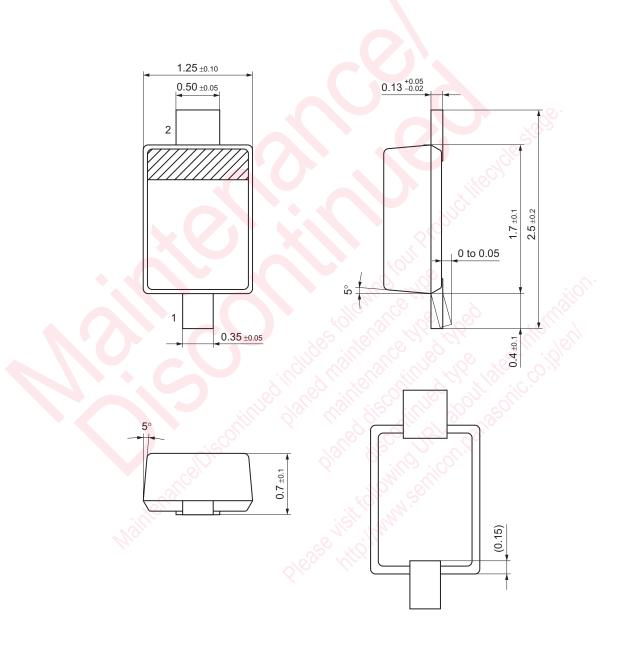
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SMini2-F3

Unit: mm



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